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(54) **Title:** GROUND SYSTEM FOR HIGH VOLTAGE SEMICONDUCTOR VALVE

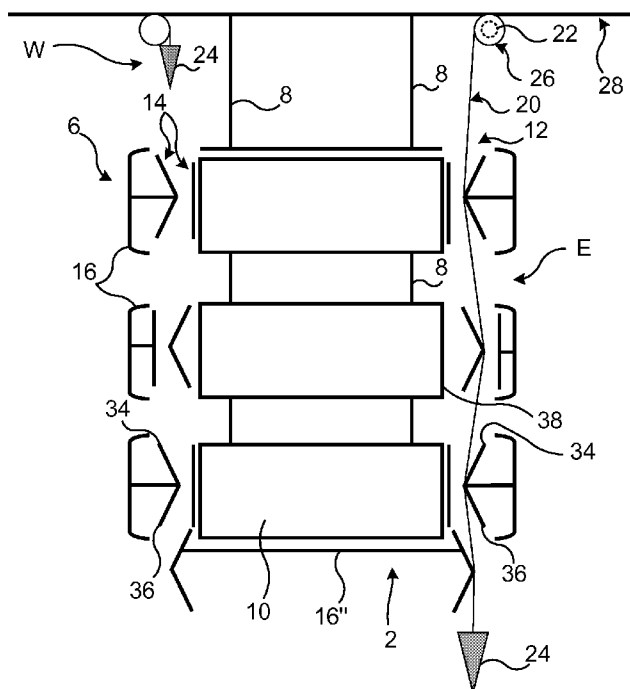


Fig. 4

(57) **Abstract:** A high voltage valve arrangement (1) comprising a high voltage valve unit (2); an external electric shield structure (6) arranged at least partially around the high voltage modular valve unit (2) and a grounding system (4). The grounding system comprising an grounding system (12) configured to be remotely extended from a retracted position (W) to an extended position (E), whereby the extendable grounding device establishes electric connection with the external shield structure when it is extended from the retracted position (W).



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— *of inventorship (Rule 4.17(iv))*

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GROUND SYSTEM FOR HIGH VOLTAGE SEMICONDUCTOR VALVE

TECHNICAL FIELD

The invention relates to a grounding system for a high voltage semiconductor
5 valve.

BACKGROUND

In valve halls where high voltage semiconductor valves may be arranged
hanging from the ceiling; regular maintenance and/or alteration may be
required. When the valve is energized no personnel should be in the valve
10 hall. For some purposes, such as maintenance, the valves need to be
deenergized to allow personnel to enter the valve hall. In case personnel have
to safely enter the valve hall, the valves need to be connected to ground to
avoid electric discharges from the valves, such as surge current strokes or
corona discharges originating from residual capacitor charges or static charge
15 in the insulating material, which may harm the personnel present in the valve
hall. So called corona shields are used in existing valves to lower the electrical
fields in order to minimize the risk for partial discharge and/or flashover. The
shields are installed around the outer surfaces of the valve. Discharges and
spontaneous discharges may also occur when the valves are deenergized.
20 Corona discharges are self sustainable partial discharges close to the highly
stressed valve. The corona discharge depends among others on humidity and
density in the atmosphere, voltage level and distance to nearby objects.

It is known to provide grounding of the valves when the valve hall is opened
and accessible for maintenance personnel and people in general, thus when
25 the valves are deenergized. The grounding is used to ensure that residual
charges in the system or arrangement, for example from the capacitors, are
discharged. For such grounding purposes an operator has to enter the valve
hall and manually install a grounding contact. Such a grounding contact must
first be moved to the right place, then connected to a plug or socket in the
30 valve hall floor and then extended to establish electric contact with the valve.

These steps have to be taken by an operator who is close to the actual grounding contact or at least in the valve hall, since the grounding contact has to be moved in the right position, connected to the plug and extended to electrically connect to the valve. Remaining charges in the capacitors or spontaneous discharges may occur during these steps, which may harm the operator. In addition, as always when human work is involved, the manual steps during such a grounding operation raise potential risk of failures or mistakes. Also, there are a plurality of valves in a valve hall. Further, the above described manual steps are time consuming and thus costly.

10 SUMMARY

It is thus an object of the present invention to provide an improved grounding system for a high voltage semiconductor valve.

This object is attained by a high voltage valve arrangement comprising a high voltage valve unit, an external electric shield structure arranged at least partially around the high voltage valve unit and a grounding system. The grounding system comprises an extendable grounding device configured to be extended from a remote location so that it may move from a retracted position into an extended position, wherein the extendable grounding device establishes electric connection with the external electric shield structure when it is extended from the retracted position.

The extendable grounding mechanism may be automatically extendable from a remote location. It may thus be remotely controlled. The remote location may even be outside the valve hall.

Advantageously, the high voltage valve arrangement may comprise a plurality of guide elements, which are electrically connected to the electric shield structure, whereby the extendable grounding device is configured to establish electric connection with at least some of the guide elements when it is in the extended position. The grounding system of the present invention has the advantage of being reliable, safe and economic.

The guide elements or at least the surface of said guide elements are made of an electrically conductive material.

There may be more than one extendable grounding device installed per valve. The shield structure may protect a bottom surface and four lateral surfaces of the valve, which may result in four extendable grounding systems per valve,
5 one for each lateral side.

Alternatively it may be possible to electrically interconnect the whole shield structure and all its elements, so that a single grounding system per valve may be enough.

10 In an embodiment the extendable grounding device may be configured to be mounted such that it extends from the retracted position in a vertical downward direction into the extended position and retracts back from the extended position in a vertical upward direction into the retracted position. This may result in additional security in the rare case that power is
15 completely cut or out. In such a case a drive or the like of the extendable grounding device may not work anymore and thus gravity can be used to put the extendable grounding device in position and thus ground the electric shield structure.

The extendable grounding device may be configured to be mounted in a
20 ceiling of a structure. This simplifies mounting and installation since valves are usually also mounted suspending from the ceiling. Alternatively, the grounding system and the extendable grounding device may be configured to be connected to a carrying structure of the valve so that the valve may be installed as a package together with the grounding system.

25 Preferably at least some of the guide elements are funnel-shaped. This smooths the movement of the extendable grounding device during an extending operation from the retracted position into the extended position. Further it ensures that each portion or element of the electric shield structure is electrically connected via the guide elements to the extendable grounding
30 system.

In an embodiment at least some of the guide elements are funnel-shaped in both ends, thus wider on a top and bottom than in the middle. This shape will smooth the movement of the extendable grounding device during a retracting or withdrawing operation from the extended position into the retracted position.

In an embodiment, the extendable grounding device may comprise a surge current limiting resistor at its free end. The free end of the extendable grounding device is the end opposite the ceiling of the structure, thus the end directed towards a floor of the structure, in case the HVDC valve arrangement is hanging.

Arranging the surge current limiting resistor at a free end of the extendable grounding system, ensures that the surge current limiting resistor is always the first element of the extendable grounding device that touches the guide elements and thus the electric shields of the electric shield structure. This ensures that any residual capacitor energy is consumed by the resistor during the grounding process and sequence.

The extendable grounding device may comprise a low-resistive electric wire and a winch wherein the low-resistive electric wire is wound onto the winch, said winch being configured to move the low-resistive electric wire from the retracted position into the extended position and back.

Using a low-resistive electric wire in combination with a winch has the advantage that the winch can be easily remote controlled and that the electric wire has a very low electric resistance so that the path of any discharge current is given, since it will follow the way of easiest resistance and thus the low resistive electric wire.

Further the low-resistive electric wire is easy to handle and to guide by the guide elements.

The low-resistive electric wire may comprise the surge current limiting resistor at its free end.

The surge current limiting resistor ensures that an electric charge can be discharged. Preferably the surge current limiting resistor is arranged at the free end of the low-resistive electric wire.

5 The surge limiting resistor may be shaped so that it easily glides into and out of the guide elements.

Advantageously the winch may be connected to a drive, which is configured to allow remote control of the winch.

10 The drive may comprise a receiver and transmitter so that an operator can extend and withdraw the winch and thus the extendable grounding device from a remote location for example by using a remote control or another interface.

The high voltage valve unit may be a hanging semiconductor high voltage valve structure comprising at least two valve layers.

15 In an embodiment the electric shield structure may comprise a plurality of corona shields arranged around the valve layers of the high voltage valve unit.

Each corona shield is in electrical contact with at least one extendable grounding device when said grounding device is extended. In case the corona shields are not electrically interconnected with one another a plurality of extendable grounding systems may be used to ground all corona shields.

20 In an embodiment each valve layer may comprise exposed surfaces, whereby each corona shield may be assigned to one exposed surface and wherein guide elements are assigned to each corona shield such that the low-resistive electric wire is guided by the guide elements in a zig-zag pattern from guide element to guide element. The guide elements assigned to an electric shield
25 may be guide element pairs.

Thus as seen in a vertical direction, the first set of guide elements assigned to a first valve layer may be slightly horizontally shifted in view of consecutive guide elements assigned to consecutive valve layers, such that the zig-zag pattern is achieved and established and such that each electric shield is
30 grounded.

Instead of using funnel-shaped guide elements it may be possible to use magnetic elements that are configured to interact with the magnetic, low-resistive electric wire when it is extended. Such magnetic guide elements may get in physical and thus electrical contact with the low resistive electric wire, which may be designed to be magnetic.

Special magnetic contact portions may be installed on the low-resistive electric wire to ensure that the wire gets in contact with the magnetic guide elements.

Generally, all terms used in the claims are to be interpreted according to their ordinary meaning in the technical field, unless explicitly defined otherwise herein. All references to "a/an/the element, device, component, system, unit, portion, etc." are to be interpreted openly as referring to at least one instance of the element, device, component, system, unit, portion, etc., unless explicitly stated otherwise.

BRIEF DESCRIPTION OF THE DRAWINGS

The invention is now described, by way of example, with reference to the accompanying drawings, in which:

Fig 1 schematically illustrates a side view of a hanging valve as it is known comprising electric shields;

Fig 2 illustrates the valve of figure 1 in a top down view;

Fig 3 schematically illustrates a high voltage semiconductor valve arrangement according to the invention comprising a grounding system;

Fig 4 schematically illustrates a similar embodiment as figure 3.

DETAILED DESCRIPTION

The invention will now be described more fully hereinafter with reference to the accompanying drawings, in which certain embodiments of the invention are shown. This invention may, however, be embodied in many different forms and should not be construed as limited to the embodiments set forth

herein; rather, these embodiments are provided by way of example so that this disclosure will be thorough and complete, and will fully convey the scope of the invention to those skilled in the art. Like numbers refer to like elements throughout the description.

- 5 Referring now to the figures, the invention is explained in more detail. Figure 1 and 2 illustrate a high voltage valve arrangement comprising a high voltage direct current (HVDC) valve unit 1', an external electric shield structure 6' and suspending insulators 8' that carry the HVDC valve unit 1'. The HVDC valve unit comprises a plurality of valve layers 10'.
- 10 In figure 1 the HVDC valve unit 1' is illustrated comprising four valve layers 10'. The valve layers 10' are installed hanging from a ceiling 28' of a structure and they are fixed to ceiling via suspending insulators 8'. Said suspending insulators 8' are also configured to interconnect the valve layers 10' in between one another.
- 15 The shield structure 6' comprises a plurality of electric shields 16' such as corona shields 16'. The electric shields 16' are arranged to cover exposed surfaces 38' of the valve layers 10' so that the electrical field strength is limited to acceptable levels. The HVDC valve unit 1' shown in figures 1 and 2 comprises in total five sides with exposed surfaces 38', the four lateral sides
- 20 and the one lower side which is facing away from the ceiling 28'.

Each side, thus each exposed surface, and each HVDC valve layer 10 may comprise an electric shield 16'. The electric shields 16' are not electrically or otherwise interconnected with one another. In the between the electric shields 16' there are gaps. A top side facing the ceiling 28' may also comprise

25 an electric shield, even if this is not shown in the figures.

The valve layers 10' may comprise at least one, two or more valve modules 11 as illustrated in figure 2. The valve modules or units 11 may be or may not be electrically interconnected in horizontal direction. Referring now to figures 3 and 4, which show embodiments of the present invention, the high voltage

30 direct current semiconductor valve arrangement 1 comprises a grounding

system 4 that is configured to ground the electric shield structure 6 and thus the electric shields 16 or corona shields of the shield structure.

The grounding system 4 comprises an extendable grounding device 12 and guide elements 14 which are part of a guide arrangement. The extendable
5 grounding device 12 comprises a low resistive electric wire 20, a winch 26 which is connected to a drive 22. The winch 26 is mounted on the ceiling 28 of the structure.

The drive 22 is configured to be remote controlled from a distance so that no personnel need to set foot into the valve hall before the corona shields are
10 properly grounded. The drive 22 may be an electric drive 22 or the like that can be easily steered via a remote located computer or another remote interface. The low-resistive electric wire 20 may be connected via the winch 26 to a grounding interface in the ceiling 28. Remote control of the winch 26 means either by way of a wireless or a wired connection.

15 A guide element arrangement and the guide elements 14 are configured to be electrically connected to the electric shield structure 6. Each electric shield 16 or corona shield is electrically connected to a guide element 14. The guide elements 14 are made of an electrically conductive material or they are at least partially covered with an electrically conductive material. The guide
20 elements 14 have a top 34 and bottom 36 as indicated in figures 3 and 4.

The guide elements 14 may be funnel-shaped and they are configured to guide the extendable grounding device 12. This means that the surfaces of some lateral guide elements 14 are inclined at least on one side of a guide element pair. The guide element pair may comprise one inclined element and
25 one vertical element as shown in figures 3 and 4. However, it is within the scope of the invention to use guide element pairs that comprise two or more inclined surfaces to guide the extendable grounding device 12. Both guide elements 14 of a guide element pair are electrically connected to the corresponding electric shield 16.

The guide elements 14 may alternatively be double funnel shaped, open at the top 34 and bottom 36 as illustrated in figures 3 on the left side and in figure 4, so that low resistive electric wire 20 and the surge current limiting resistor 24 may be easily extended and retracted without congestion or blockage at the guide elements 14.

Each valve layer 10 has a plurality of electric shields 16 assigned to it, in the illustrated embodiment four electric shields 16 one on each lateral side of the square-shaped HVDC valve unit 2, besides the lowest valve layer 10, which in addition has an end-electric shield 16" assigned to it as shown in figure 4. The guide elements 14 assigned to the electric shields 16 of one of the valve layers 16 are slightly shifted in a horizontal direction in view of the guide elements 14 assigned to the electric shields of a consecutive valve layer 10, to ensure that the low resistive electric wire 20 establishes electric contact with each guide element 14 and thus with each electric shield 16 on its way to the extended position E. The low resistive electric wire 20 will follow a zig-zag pattern as a result of the horizontally shifted guide elements 14, as best illustrated in figure 4.

The winch 26 is configured to receive the low-resistive electric wire 20 so that it can be extended, thus uncoiled, from a retracted or withdrawn position W and retracted or withdrawn, thus wound up, from an extended position E, as illustrated in figure 4. The low-resistive electric wire 20 comprises a surge current limiting resistor 24 at its free end. The surge current limiting resistor 24 is configured to dissipate a potential surge current or any other spontaneous discharge. As illustrated in figures 3 and 4, the surge current limiting resistor 24 is specifically shaped in order to facilitate the guidance of the low-resistive electric wire 20 by the guide elements 14. Preferably the surge current limiting resistor 24 is arrow-shaped or double arrow-shaped as indicated in figure 3 and 4, it is however clear that any other shape that allows or facilitates the guidance by the guide elements may be used and falls within the scope of the invention.

The grounding system 4 as illustrated in the figures 3 and 4 comprises four extendable grounding devices 12, each on one of the four lateral sides of the high voltage direct current semiconductor valve unit 2.

5 It falls within the scope of the invention to use only one extendable grounding device 12 for the high voltage direct current valve unit 2. In such an embodiment, the electric shields 16 of the electric shield structure should then however be electrically interconnected among each other.

The valve modules of the valve layers 10 and the HVDC valve unit may for example be mercury-arc valves, thyristor valves or transistors.

10 The valve layers 10 are connected to the ceiling by the suspending insulators 8, as described in view of figures 1 and 2, however, the valve layers 10 may be connected and arranged within a valve carrying scaffolding (not shown) or the like. In such an embodiment the scaffolding may carry the electric shield structure 6 and thus the grounding system 4 as well.

15 The invention has now been described by indicating how the grounding system 4 interacts with the electric shield structure 6 and how the extendable grounding device 12 interacts with the guide elements 14. It is however possible to avoid the guide elements 14 in the grounding system 4 and position the electric shields 16 in view of the extendable grounding device 12
20 in a way such that the surge current limiting resistor 24 and its shape respectively establish electric contact with each electric shield 16 of one side of the HVDC valve unit 2, thus ensuring the low resistive electric wire 20 is in electric contact with each electric shield 16, 16" assigned to one lateral side and/or the lower side of the valve unit 2. The electric shields 16 may be
25 positioned eccentrically to ensure that the low resistive electric wire 20 establishes contact with each electric shield 16 of one side of the valve unit 2 on its way from the retracted position W to the extended position E and when it is actually in the extended position E.

It is to be noted that instead of the surge current limiting resistor 24 an
30 ordinary element made of an electrically conductive material may be used to

guide the low resistive electric wire 20 and in order to provide some weight to straighten out the wire 20 and to ease the extending and retracting operation of the extendable grounding device 12 and low resistive electric wire 20, respectively.

- 5 The surge current limiting resistor 24 is arranged at a free end of the extendable grounding device 4. The surge current limiting resistor 24 is configured to be the first element or portion of the extendable grounding device that establishes electrical contact with guide elements 16 and thus with the electric shields 16, when the extendable grounding device 4 is moved
10 from the retracted position W to the extended position E.

The extendable grounding device 12 has been described and illustrated by a winch 26, a drive 22 and an electric wire 20. It falls within the scope of the invention to use any other suitable extending device that may be used for grounding such as an extendable and retractable spring system, an
15 extendable and retractable scaffolding structure or just an extendable and retractable telescopic arrangement that are configured to establish electric contact with the electric shields 16 assigned to one side of the valve unit 2 on their way from the retracted position W to the extended position E and in the extended position E.

- 20 The grounding system 4 only grounds the external electric shield structure 6 and not the HVDC valve unit 2 itself.

Instead of using a hanging high voltage valve arrangement 1 with suspending insulators 8, it is possible to install the high voltage valve arrangement 1 standing on a valve hall floor 30 of the structure or valve hall. In such an
25 embodiment the extendable grounding device 4 may be a rigid extendable grounding device such as a scaffolding structure that may be extended or a telescopic extendable device that may be extended from the valve hall floor 30 towards the ceiling 28. Such a grounding device 4 also comprises a surge current limiting resistor at its free end to ensure that this resistor is the first
30 element to establish electric contact with the guide elements 16.

The invention has mainly been described above with reference to a few embodiments. However, as is readily appreciated by a person skilled in the art, other embodiments than the ones disclosed above are equally possible within the scope of the invention, as defined by the appended patent claims.

CLAIMS

1. A high voltage valve arrangement (1) comprising
a high voltage valve unit (2);
an external electric shield structure (6) arranged at least partially around
5 the high voltage modular valve unit (2); and
a grounding system (4), the grounding system comprising an extendable
grounding device (12) configured to be remotely extended from a retracted
position (W) to an extended position (E), wherein the extendable
grounding device establishes electric connection with the external shield
10 structure when it is extended from the retracted position (W).
2. The high voltage valve arrangement according to claim 1, comprising a
plurality of guide elements (14), which are electrically connected to the
electric shield structure (6), wherein the extendable grounding device (12)
is configured to establish electric connection with at least some of the
15 guide elements (14) when it is in the extended position (E).
3. The high voltage valve arrangement according to claim 1 or 2, wherein
the extendable grounding device (12) is configured to be mounted such
that it extends from the retracted position (W) in a vertical downward
direction (A) into the extended position (E) and withdraws back from the
20 extended position (E) in a vertical upward direction (A') into the retracted
position.
4. The high voltage valve arrangement according to the previous claim,
wherein the extendable grounding device (12) is configured to be mounted
in a ceiling (28) of a structure.
- 25 5. The high voltage valve arrangement according to any of the previous
claims, wherein at least some of the guide elements (14) are funnel-
shaped.
6. The high voltage valve arrangement according to the previous claim,
wherein at least some of the guide elements (14) are funnel-shaped in both
30 ends, thus wider on a top (34) and bottom (36) than in the middle.

7. The high voltage valve arrangement according to any of the previous claims, wherein the extendable grounding device (4) comprises a surge current limiting resistor (24) arranged at its free end.

5 8. The high voltage valve arrangement according to any of the previous claims, wherein the extendable grounding device (12) comprises a low-resistive electric wire (20) and a winch (26) wherein the low-resistive electric wire (20) is wound onto the winch (26), said winch being configured to move the low-resistive electric wire from the retracted position (W) into the extend position (E) and back.

10 9. The high voltage valve arrangement according to the previous claims, wherein the low-resistive electric wire (20) comprises the surge current limiting resistor (24) at its free end.

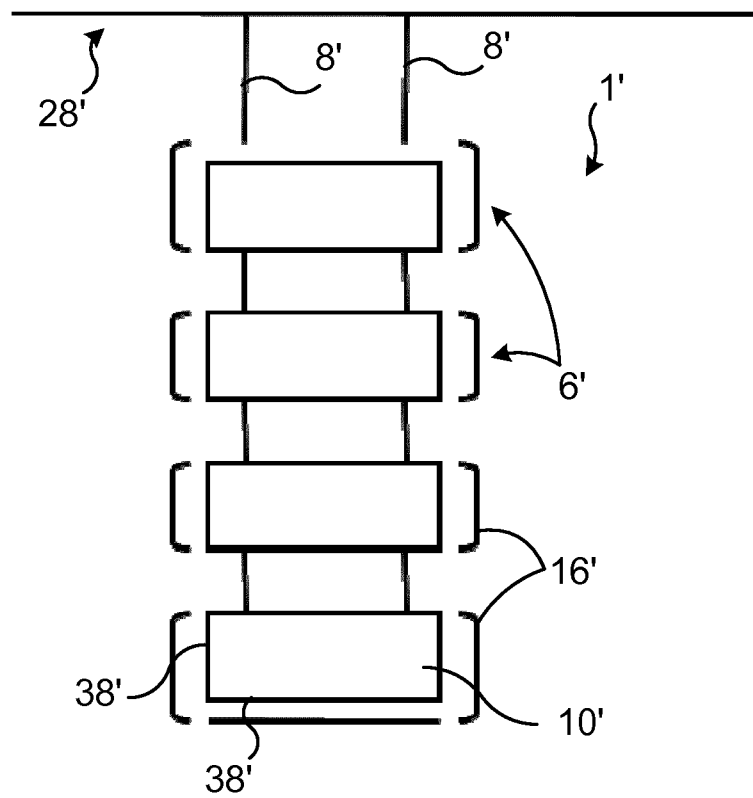
15 10. The high voltage valve arrangement according to any one of claims 8 or 9, wherein the winch (26) is connected to a drive (22), which is configured to allow remote control of the winch (26).

11. The high voltage valve arrangement according to any of the previous claims, wherein the high voltage valve unit (2) is a hanging semiconductor high voltage valve structure comprising at least two valve layers (10).

20 12. The high voltage valve arrangement according to the previous claim, wherein the electric shield structure (6) comprises a plurality of corona shields (16) arranged around the valve layers (10) of the high voltage valve unit (2).

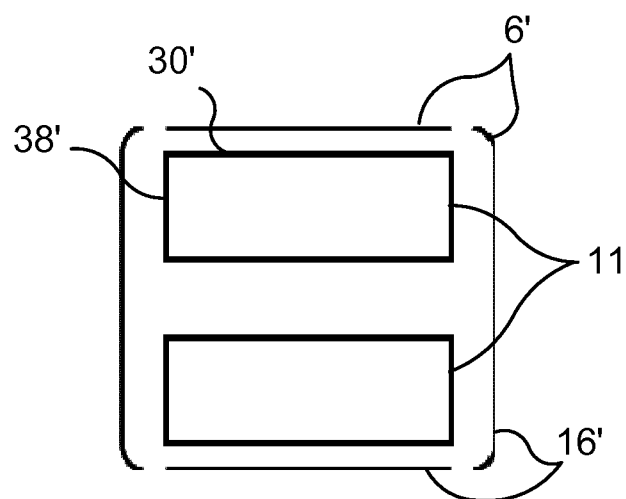
25 13. The high voltage valve arrangement according to the previous claim, wherein each valve layer (10) comprises exposed surfaces (38), each corona shield (16) being assigned to one exposed surface (38) and wherein guide elements (14) are assigned to each corona shield (16) such that the low-resistive electric wire (20) is guided by the guide elements (14) in a zig-zag pattern from guide element (14) to consecutive guide element (14').

1/3



Prior Art

Fig. 1



Prior Art

Fig. 2

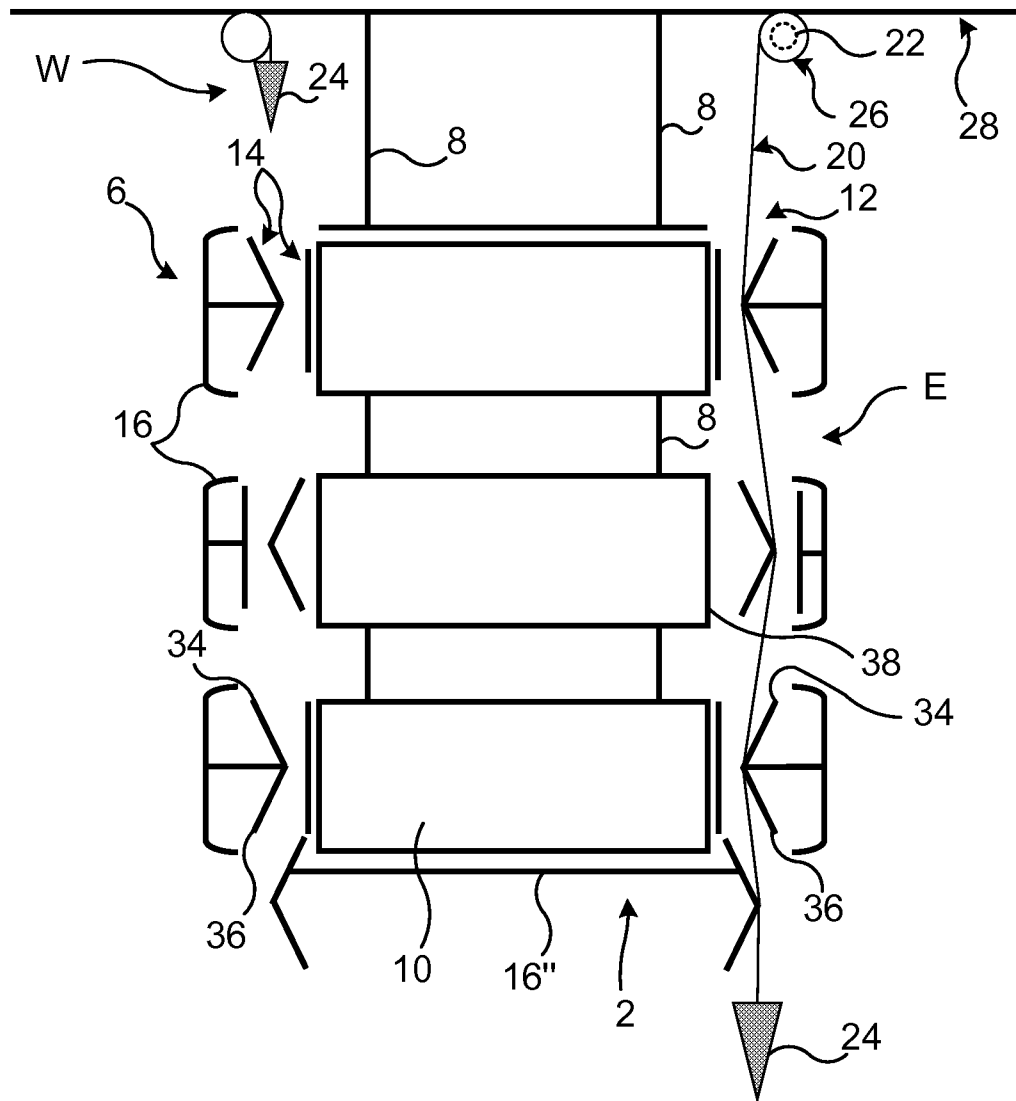


Fig. 4

INTERNATIONAL SEARCH REPORT

International application No

PCT/EP2013/073017

A. CLASSIFICATION OF SUBJECT MATTER

INV. H01L23/473 H01L25/11
ADD.

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

H01L

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)

EPO-Internal, WPI Data

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	WO 2013/075754 A1 (ALSTOM TECHNOLOGY LTD [CH]; ELLIOTT ROBERT [GB]) 30 May 2013 (2013-05-30) abstract; figure 1 -----	1
A	WO 2010/094338 A1 (ABB TECHNOLOGY AG [CH]; HEDBLAD PER-OLOF [SE]; WU DONG [SE]) 26 August 2010 (2010-08-26) the whole document -----	1
A	CN 201 883 727 U (GUANGDONG ELECTRICAL POWER DESIGN INST) 29 June 2011 (2011-06-29) abstract -----	1
A	WO 2007/149015 A1 (ABB RESEARCH LTD [CH]; MING LI [SE]; WU DONG [SE]) 27 December 2007 (2007-12-27) line 18 - page 7, line 27 -----	1



Further documents are listed in the continuation of Box C.



See patent family annex.

* Special categories of cited documents :

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Date of the actual completion of the international search

18 August 2014

Date of mailing of the international search report

02/09/2014

Name and mailing address of the ISA/

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INTERNATIONAL SEARCH REPORT

Information on patent family members

International application No

PCT/EP2013/073017

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